



# **BYK-A 530**

Silicone and polymer-containing defoamer/air release additive for solvent-borne and solvent-free coatings, for plastic systems (ambient-curing and pultrusion applications), adhesives and sealants. Particularly recommended for epoxy resin systems.

## **Product Data**

#### Composition

Solution of foam-destroying polymers and polysiloxanes.

#### **Typical Properties**

The values indicated in this data sheet describe typical properties and do not constitute specification limits.

Density (20 °C): 0.81 g/ml Refractive index (20 °C): 1.448

Solvents: Hydrocarbon mixture

Flash point: 95 °C

#### **Food Contact Legal Status**

For the current food contact legal status, please contact our product safety department or visit www.byk.com for further information.

## **Applications**

## **Coatings Industry**

## **Special Features and Benefits**

BYK-A 530 is a highly effective defoamer and air release additive for solvent-borne and solvent-free coating systems. It is effective during manufacture and processing and is particularly recommended for epoxy resin systems.

#### **Recommended Use**

Protective coating systems	Х
Industrial coatings	Υ
Architectural coatings	Υ
Wood and furniture coatings	Υ

X especially recommended Y recommended

#### **Recommended Levels**

0.2-0.8% additive (as supplied) based upon total formulation.

The above recommended levels can be used for orientation. Optimal levels are determined through a series of laboratory tests.

## **Incorporation and Processing Instructions**

To achieve optimal defoaming, the defoamer should be added already to the millbase. If incorporating at a later stage, sufficiently high shear forces must be applied to ensure a good distribution and to prevent cratering.





## **Ambient-curing Plastic Systems**

#### **Special Features and Benefits**

BYK-A 530 is a highly effective air release additive, which reduces the formation of foam during the manufacture and processing of epoxy resin systems to obtain blister-free surfaces.

#### **Recommended Levels**

0.5-2% additive (as supplied) based upon total formulation.

The above recommended levels can be used for orientation. Optimal levels are determined through a series of laboratory tests.

## **Incorporation and Processing Instructions**

Stir into the resin before adding other components. It is also possible to add the additive to finished systems.

#### **Pultrusion of Plastic Systems**

#### **Special Features and Benefits**

Prevention of air entrapment during manufacture and application (pultrusion). Particularly recommended for plastic systems which are based on epoxy resins.

#### **Recommended Levels**

0.5-2% additive (as supplied) based upon the resin and curing agent.

The above recommended levels can be used for orientation. Optimal levels are determined through a series of laboratory tests.

## **Incorporation and Processing Instructions**

Stir into the resin before adding other components.

#### **Adhesives & Sealants**

## **Special Features and Benefits**

BYK-A 530 is a highly effective air release additive, which reduces the formation of foam during the manufacture and processing of adhesives and sealants. Particularly recommended for epoxy resin-based systems.

#### **Recommended Levels**

0.5-2% additive (as supplied) based upon total formulation.

The above recommended levels can be used for orientation. Optimal levels are determined through a series of laboratory tests.

## **Incorporation and Processing Instructions**

Stir into the resin before adding other components.

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